

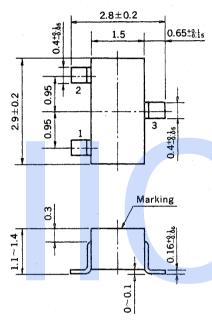
SILICON SWITCHING DIODES

1S2835,1S2836

HIGH SPEED SWITCHING SILICON EPITAXIAL DOUBLE DIODES: COMMON ANODE MINI MOLD

PACKAGE DIMENSIONS

in millimeters



Connection Diagram (Top View) 2 Anode

Cathode Marking 1S2835 A3 1S2836 A4 Cathode

FEATURES

- Low capacitance: C_t = 2.5 pF TYP.
- High speed switching: t_{rr} = 4.0 ns MAX.
- Wide applications including switching, limitter, clipper.
- Double diode configuration assures economical use.

ABSOLUTE MAXIMUM RATINGS

Maximum Voltages and Currents (Ta = 25 °C)

| | | | 1S2835 | 1S2836 | |
|-----|----------------------------|----------------------|-------------|-------------|-------|
| | Peak Reverse Voltage | V _{RM} | 35 | 75 | V |
| | DC Reverse Voltage | VR | 30 | 50 | , V |
| | Surge Current (1 μs)* | IFSM | 6.0 | 6.0 | Α |
| | Surge Current (1 μs) | FSM | 4.0 | 4.0 | Α |
| | Peak Forward Current* | I _{FM} | 450 | 450 | mΑ |
| | Peak Forward Current | IFM | 300 | 300 | mΑ |
| | Average Rectified Current* | l _o | 150 | 150 | mΑ |
| | Average Rectified Current | 10 | 100 | 100 | mΑ |
| Ma | ximum Temperatures | | | | |
| | Junction Temperature | T_{j} | 125 | 125 | °C |
| | Storage Temperature Range | T_{stg} | -55 to +125 | -55 to +125 | °C |
| The | ermal Resistance | | | | |
| | Junction to Ambient* | R _{th(j-a)} | 1.0 | 1.0 | °C/mW |
| | Junction to Ambient | $R_{th(j-a)}$ | 0.67 | 0.67 | °C/mW |
| | | | | | |

^{*} Both diodes loaded simultaneously.

ELECTRICAL CHARACTERISTICS (Ta = 25 °C)

| CHARACTERISTIC | SYMBOL | 1S2835 (A3) | | 1S2836 (A4) | | | UNIT | TEST CONDITIONS | |
|-----------------------|-----------------|-------------|------|-------------|------|------|------|-----------------|---------------------------------|
| CHARACTERISTIC | | MIN. | TYP. | MAX. | MIN. | TYP. | MAX. | ONLI | 1E31 CONDITIONS |
| | V _{F1} | | 0.72 | 1.0 | | 0.72 | 1.0 | V | l _F = 10 mA |
| Forward Voltage | V _{F2} | | 0.88 | 1,1 | | 0.88 | 1.1 | V | IF = 50 mA |
| | V _{F3} | | 1.0 | 1.2 | | 1.0 | 1.2 | ٧ | I _F = 100 mA |
| Reverse Current | IR | | | 0.1 | | | | μΑ | V _R = 30 V |
| Heverse Current | l _R | | | | | | 0.1 | μА | V _R = 50 V |
| Capacitance | Ct | | 2.5 | 4.0 | | 2.5 | 4.0 | рF | V _R = 0, f = 1.0 MHz |
| Reverse Recovery Time | t _{rr} | | | 4.0 | | | 4.0 | ns | See Test Circuit. |

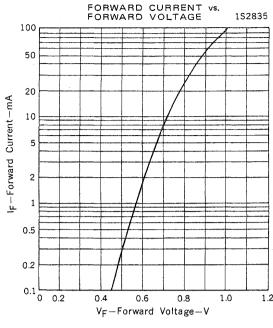
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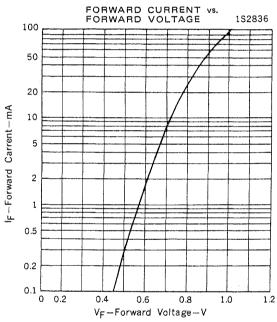
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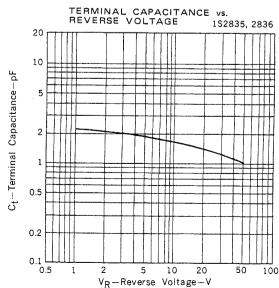
(Previous No. DC-1054A)
Date Published July 2002 N CP(K)

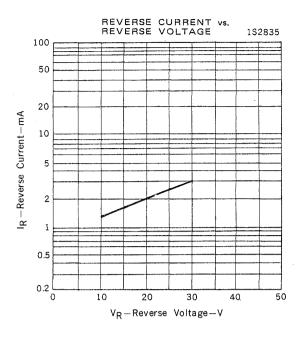
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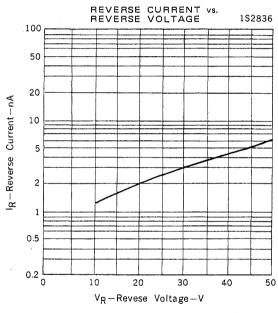
TYPICAL ELECTRICAL CURVES (Ta = 25 °C)

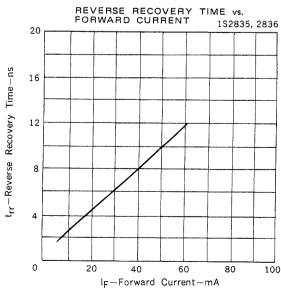




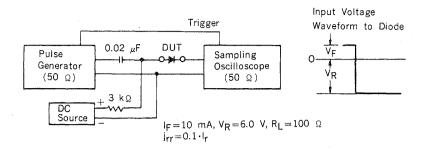


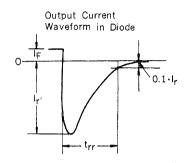






REVERSE RECOVERY TIME (trr) TEST CIRCUIT





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